

Frepenca EHS Synergy Meeting

A	Host: Globetronics		19/07/06	2.00 pm-4.30pm
B	Attendance and distribution list			
#	Name	Company		
1	Ramachandran, William Ng Jeng Wai	B. Braun Medical Industries		
2	Jaafar bin Harun	Fairchild Semiconductor		
3	KM Chan/CC Lee/GL Chan/LC Tan	Globetronics		
4	Palani	LKT		
5	Ooi Wat Tang	Osram		
6	SE Lee/ Omar	AMD		
7	Lim Beng Sun / Izham	Penfabric Mill 1		
8	HA Ling	SPANSION		
9	MOGAN	Intel		
Copy:	Mr. Ching Neng Shyan			Frepenca
C	Next meeting to be held:		13.09.06	Fairchild
D	The Committee thanked KM Chan, LC Tan and CC Lee (Globetronics) for hosting this meeting. Special thanks is extended to LC Tan who had shared on Emergency Preparedness information.			
E	Minutes	Who	Date	Status
1	Talk on Emergency Preparedness	LC Tan	July 19/06	Completed.
2	Propose Cross-learning Visits among members. WT Ooi shared the matrix and scope of the activities and potential companies to participate.	All interested members	-	KIV
3	Intel proposed a Technical EHS Forum where specific technical issues related to EHS can be discussed in the presence to authorities. Members are encouraged to send in any concerns, issues faced to WT Ooi prior to the forum.	WT Ooi and Morgan	August 17/06	Had talked to DOSH Director. The proposal on the agenda has been accepted. - the Forum has been confirmed at PSDC.
4	Propose to give token of appreciation to presenters during meeting (using EHS fund in Frepenca).	WT Ooi	July 19/06	Mr. Ching agreed to this proposal.
5	Ramachandran raised two proposals during the meeting: a. To initiate benchmarking on EHS among members. b. To establish/foster good co-operation among neighbouring companies on emergency events in each phases.	fyi	July 19/06	No issues.